## PATENT APPLICATION

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of Docket No: Q78933 Tadashi IINO, et al. Appln. No.: 10/581,675 Group Art Unit: 1796 Confirmation No.: 6929 Examiner: Khanh Tuan NGUYEN Filed: June 5, 2006 ELECTROCONDUCTIVE RESIN COMPOSITION AND MOLDED PRODUCT For: THEREOF AMENDMENT UNDER 37 C.F.R. § 1.111 MAIL STOP AMENDMENT Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 Sir: In response to the Office Action dated April 14, 2009, please amend the above-identified application as follows on the accompanying pages. TABLE OF CONTENTS AMENDMENTS TO THE CLAIMS......2

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